Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
Li	1842694	((serial lot) near number) (identifica\$5 "ID") (manufacture near time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 10:41
L2	967	((external2 remov\$4) WITH (memory storage) WITH (program code instruction application)) SAME L1	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 10:41
L14	1	((TAKAHITO) near2 (NAKANO)).INV.	US-PGPUB; USPAT	OR	ON	2007/10/11 12:00
L15	3	((SATOSHI) near2 (AKUI)).INV.	US-PGPUB; USPAT	OR	ON	2007/10/11 12:00
L16	3	((SATOSHI) near2 (AKUI)).INV.	US-PGPUB; USPAT	OR	ON	2007/10/11 12:00
L17	3	((HIROYUKI) near2 (KIBA)).INV.	US-PGPUB; USPAT	OR	ON	2007/10/11 12:00
L18	1757	read\$3 NEAR3 (instruction command demand program application code) NEAR4 (chip ic (integrated adj circuit) package wafer) WITH (lot date time position ID ident\$8 name model type characteristic)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:05
L19	244	L18 WITH (output send)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:05
L20	21	L19 SAME (execut\$3 run\$4)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:05
L21	14167	((365/200) or (710/1,5-7) or (711/103,164,167,170)).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/11 12:09
L22	1842694	((serial lot) near number) (identifica\$5 "ID") (manufacture near time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:07
L23	10020	(program code) SAME (semiconductor chip) SAME L22	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:07
L24	9775043	(transfer\$4 transmission move\$5 writ\$4 read\$4 send\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:07

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L25	5748	L23 SAME L24	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:07
L26	99	L25 AND L21	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:10
L27	14885	((365/200) or (710/1,5-7) or (711/103,164,167,170) or (712/227)).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/10/11 12:09
L28	103	L25 AND L27	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:10
L29	338224	(output send read) NEAR2 (program code instruction software firmware application)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:15
L30	759	L25 SAME L29	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:15
L31	13	L30 AND L21	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:15
L32	13	L30 AND L27	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/10/11 12:15
L33	19799 ·	((semiconductor \$5chip \$5processor CPU controller chip ic (integrated adj circuit) package wafer) AND (storage memory) AND (lot date time position ID ident\$8 name model type characteristic) AND (instruction command demand program application code software firmware) AND (read\$3 write\$3 get\$4 transfer\$4)).clm.	US-PGPUB	OR	ON	2007/10/11 12:55

L34	50	("3560764" "3564300" "3573754" "3576549" "3584223" "3590248" "3596055" "3601698" "3611320" "3611437" "3614438" "3614447" "3614739" "3617753" "3618052" "3618580" "3623026" "3623027" "3626244" "3628023" "3632969" "3632970" "3638204" "3639683" "3651349" "3655986" "3656118" "3656121" "3659149" "3665210" "3674995" "3679981" "3683201" "3683337" "3684842" "3686645" "3691533" "3693003" "3697962" "3699375" "3700852" "3701044" "3701979" "3705385" "3706892" "3706914" "3710352" "3718915" "3728695" "3737876").pn.	US-PGPUB; USPAT	OR	ON	2007/10/11 12:47
L35	50	("5386131" "4460980" "4807005" "4825056" "5705824" "4292677" "4323842" "4385308" "4405993" "4472792" "4472726" "4491858" "4539658" "4592022" "4860255" "4864168" "4954989" "4987558" "5237180" "5255071" "5260772" "5270797" "5278704" "5317540" "5325333" "5332722" "5357134" "5360763" "5365478" "5414275" "5448421" "5448520" "5463610" "5464673" "5485017" "5648135" "5689457" "5717675" "5720861" "5732037" "5780886" "5808951" "5847565" "5989927" "6013950" "6233722" "4250206" "4250569" "4250568" "4254427").pn.	US-PGPUB; USPAT	OR	ON	2007/10/11 12:51
L36	2901	((semiconductor \$5chip \$5processor CPU controller chip ic (integrated adj circuit) package wafer) SAME (storage memory) SAME (lot date time position ID ident\$8 name model type characteristic) SAME (instruction command demand program application code software firmware) SAME (read\$3 write\$3 get\$4 transfer\$4)).clm.	US-PGPUB	OR	ON	2007/10/11 12:56
L37	5	((semiconductor \$5chip \$5processor CPU controller chip ic (integrated adj circuit) wafer) SAME (storage memory) SAME (lot date time position ID ident\$8 name model type characteristic) SAME (instruction command program application code software firmware) SAME (read\$3 get\$4) SAME (external\$2 out\$1side) SAME (remov\$4)).clm.	US-PGPUB	OR	ON	2007/10/11 13:07
L38	475	((semiconductor \$5chip \$5processor CPU controller chip ic (integrated adj circuit) wafer) AND (storage memory) AND (lot date time position ID ident\$8 name model type characteristic) AND (instruction command program application code software firmware) AND (read\$3 get\$4) AND (external\$2 out\$1side) AND (remov\$4)).clm.	US-PGPUB	OR	ON	2007/10/11 13:09
L39	14	((semiconductor \$5chip \$5processor CPU controller chip ic (integrated adj circuit) wafer) AND ((storage memory) NEAR5 (lot date time position ID ident\$8 name model type characteristic)) AND ((instruction command program application code software firmware) NEAR5 (read\$3 get\$4)) AND ((external\$2 out\$1side) NEAR5 (remov\$4))).clm.	US-PGPUB	OR	ON	2007/10/11 13:10
S1	12	"735680"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 09:59
S 2	1644009	(semiconduct\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 09:59
S 3	8659050	(transfer\$4 transmission move\$5 writ\$4 read\$4 send\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 10:45
S4	4519175	(memory stor\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 10:01

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S5	132192	((serial lot identifica\$5 "ID") near number)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 10:43
S6	606	S2 SAME S3 SAME S4 SAME S5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2006/02/23 10:05
S7	204	S2 SAME (S3 WITH S4 WITH S5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 10:07
S8	6	("20020143409" "6363487" "6886087").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 10:10
S9	5.	("5048085" "5184481" "5818771" "5912849" "6681304").PN. OR ("6886087").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 10:11
S10	1410719	((serial lot) near number) (identifica\$5 "ID") (manufacture near time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 10:45
S11	10417111	(transfer\$4 transmission move\$5 writ\$4 read\$4 send\$3 output\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 10:45
S12	3208	S2 AND (S10 NEAR4 S4 NEAR4 S11)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:02
S13	1644009	(semiconduct\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:02
S14	4519175	(memory stor\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:02
S15	1410719	((serial lot) near number) (identifica\$5 "ID") (manufacture near time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:02
S16	10417111	(transfer\$4 transmission move\$5 writ\$4 read\$4 send\$3 output\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	.OR	ON	2006/02/23 12:02

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S17	310	S13 SAME (S15 NEAR4 S14 NEAR4 S16)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:05
S18	8659050	(transfer\$4 transmission move\$5 writ\$4 read\$4 send\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:05
S19	132192	((serial lot identifica\$5 "ID") near number)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:05
S20	204	S13 SAME (S18 WITH S14 WITH S19)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:05
S21	231	S17 NOT S20	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:07
S22	10	("4485437" "5079725" "5319598" "5642307" "5794066" "5860134" "6085284" "6178483" "6181629" "6381671").PN. OR ("6889299").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 12:16
S23	· 54	("4055802" "4150331" "4166574" "4419747" "4451903" "4510673" "5056061" "5254482").PN. OR ("5642307"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 12:20
S24	1	"6600683".pn.	USPAT	OR	ON	2006/02/23 14:40
S25	7479494	(control\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2006/02/23 16:15
S26	8051048	(input\$4 output\$4 writ\$3 read\$3 send\$3 transmit\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2006/02/23 16:16
S27	1644009	(semiconduct\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 16:17
S28	4519175	(memory stor\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 16:17
S29	1410719	((serial lot) near number) (identifica\$5 "ID") (manufacture near time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 16:17
S30	300	(S25 NEAR3 S26) SAME (S28) SAME (S27) SAME (S29)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 16:20

S31	53	("4525809" "4825056" "4472792" "4491858" "4539658" "4592022" "4849804" "4860255" "4871257" "4954989" "5272370" "5325333" "5365478" "5448520" "5450332" "5686714" "5689457" "5732037" "5808951" "5808933" "5949047" "6031985" "6233722" "4250569" "4250568" "4259729" "4281376" "4287569" "4298962" "4319279" "4321489" "4336604" "4371956" "4377855" "4379345" "4487402" "4396998" "4399450" "4433378" "4463270" "4477853" "4499560" "4542306" "4549284" "4550492" "4564808" "4571607" "4575858" "4580070" "4598174").pn.	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2006/02/24 09:56
S32	50	("5386131" "4460980" "4807005" "4825056" "5705824" "4292677" "4323842" "4385308" "4405993" "4472792" "4472726" "4491858" "4539658" "4592022" "4860255" "4864168" "4954989" "4987558" "5237180" "5255071" "5260772" "5270797" "5278704" "5317540" "5325333" "5332722" "5357134" "5360763" "5365478" "5414275" "5448421" "5448520" "5463610" "5464673" "5485017" "5648135" "5689457" "5717675" "5720861" "5732037" "5780886" "5808951" "5847565" "5989927" "6013950" "6233722" "4250266" "4250569" "4250568" "4254427").pn.	US-PGPUB; USPAT	OR	ON	2006/08/04 14:11
S33	9986	(wafer) near (number)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:12
S34	1689859	semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:12
S35	8545	S33 AND S34	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:13
S36	17669	wafer near position	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:13
S37	2283	S33 AND S36	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:13
S38	377	S33 SAME S36	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:13
S39	327	S38 AND S34	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:13
\$40	53	S38 SAME S34	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:13
S41	1	("2004/0174753").URPN.	USPAT	OR	ON	2006/08/04 14:14

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S42	11	("20030084219" "20040174753" "4646300" "5422885" "5548559" "5734819" "5860080" "5930359" "5935229" "5952934" "6600686").PN. OR ("7073018").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/04 14:21
S43	1	"5856923".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/04 14:22
S44	7738002	(control\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2006/08/04 14:41
S45	8329191	(input\$4 output\$4 writ\$3 read\$3 send\$3 transmit\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:41
S46	1708194	(semiconduct\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:41
S47	4713149	(memory stor\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2006/08/04 14:41
S48	1524929	((serial lot) near number) (identifica\$5 "ID") (manufacture near time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:41
S49	315	(S44 NEAR3 S45) SAME (S47) SAME (S46) SAME (S48)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/04 14:41
S50	1	((TAKAHITO) near2 (NAKANO)).INV.	US-PGPUB; USPAT	OR	ON	2006/08/04 14:42
S51	. 2	((HIROYUKI) near2 (KIBA)).INV.	US-PGPUB; USPAT	OR	ON	2006/08/04 14:42
S52	2	((SATOSHI) near2 (AKUI)).INV.	US-PGPUB; USPAT	OR	ON	2006/08/04 14:42
S53	10	("4485437" "5079725" "5319598" "5642307" "5794066" "5860134" "6085284" "6178483" "6181629" "6381671").PN. OR ("6889299").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/30 10:49
S54	1694848	((serial lot) near number) (identifica\$5 "ID") (manufacture near time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 16:11
S55	9143	(program code) SAME (semiconductor chip) SAME S54	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 16:11
S56	9402511	(transfer\$4 transmission move\$5 writ\$4 read\$4 send\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 16:14

S57	5251	S55 SAME S56	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 16:14
S58	62	("4055802" "4150331" "4166574" "4419747" "4451903" "4510673" "5056061" "5254482").PN. OR ("5642307"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/04/03 11:23
S59	10	("4485437" "5079725" "5319598" "5642307" "5794066" "5860134" "6085284" "6178483" "6181629" "6381671").PN. OR ("6889299").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/04/03 11:26
S60	13394	((365/200) or (710/1,5-7) or (711/103,164,167,170)).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/03 11:36
S61	1695551	((serial lot) near number) (identifica\$5 "ID") (manufacture near time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/03 11:36
S62	9149	(program code) SAME (semiconductor chip) SAME S61	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/03 11:36
S63	9405232	(transfer\$4 transmission move\$5 writ\$4 read\$4 send\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2007/04/03 11:36
S64	5254	S62 SAME S63	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/03 11:36
S65	92	S64 AND S60	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 10:49
S66	1	((TAKAHITO) near2 (NAKANO)).INV.	US-PGPUB; USPAT	OR	ON	2007/04/03 16:13
S67	3	((HIROYUKI) near2 (KIBA)).INV.	US-PGPUB; USPAT [.]	OR	ON	2007/04/03 16:13
S68	3	((SATOSHI) near2 (AKUI)).INV.	US-PGPUB; USPAT	OR	ON	2007/04/03 16:14

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S69	50	("5386131" "4460980" "4807005" "4825056" "5705824" "4292677" "4323842" "4385308" "4405993" "4472792" "4472726" "4491858" "4539658" "4592022" "4860255" "4864168" "4954989" "4987558" "5237180" "5255071" "5260772" "5270797" "5278704" "5317540" "5325333" "5332722" "5357134" "5360763" "5365478" "5414275" "5448421" "5448520" "5463610" "5464673" "5485017" "5648135" "5689457" "5717675" "5720861" "5732037" "5780886" "5808951" "5847565" "5989927" "6013950" "6233722" "4250206" "4250569" "4250568" "4254427").pn.	US-PGPUB; USPAT	OR	ON	2007/04/04 09:37
S70	13415	((365/200) or (710/1,5-7) or (711/103,164,167,170)).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/05 10:49
S71	1696772	((serial lot) near number) (identifica\$5 "ID") (manufacture near time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 10:49
S72	9164	(program code) SAME (semiconductor chip) SAME S71	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 10:49
S73	9409707	(transfer\$4 transmission move\$5 writ\$4 read\$4 send\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 10:49
S74	5264	S72 SAME S73	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 10:49
S75	93	S74 AND S70	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:06
S76	6	S75 AND (JTAG)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:00
\$77	176	S74 AND JTAG	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:08
\$78	237626	(output read) NEAR2 (program code instruction)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:08

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S80	132338	(output read) ADJ2 (program code instruction) .	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:23
S82	613	S74 SAME S78	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:24
S83	. 6	S82 AND JTAG	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:18
S84	5	S82 AND (boundary NEAR scan)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:18
S85 [°]	187718	(output send) NEAR2 (program code instruction software firmware application)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:25
S86	198	S74 SAME S85	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:26
S87	1	S86 AND JTAG	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:25
S88	317753	(output send read) NEAR2 (program code instruction software firmware application)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:25
S89	707	S74 SAME S88	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:27
\$90	9	S89 AND JTAG	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:26

S91	93	S74 AND S70	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:27
S92	12	S89 AND S70	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 11:27
S93	1	("2004/0174753").URPN.	USPAT	OR	ON	2007/04/05 12:04
S94	1696772	((serial lot) near number) (identifica\$5 "ID") (manufacture near time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 12:36
\$95	1808	(test WITH (device chip)) SAME (program firmware configuration application instruction) SAME (S94)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 13:01
S96	994	(test WITH (device chip) WITH (S94)) SAME (program firmware configuration application instruction)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 13:01
S97	106	(test WITH (device chip) WITH (S94)) SAME ((output send read) NEAR2 (program code instruction software firmware application))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 13:02
S98	39	S97 AND semiconductor	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 13:03
S99	1651	read\$3 NEAR3 (instruction command demand program application code) NEAR4 (chip ic (integrated adj circuit) package wafer) WITH (lot date time position ID ident\$8 name model type characteristic)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 15:43
S10 0	231	S99 WITH (output send)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 15:44
S10 1	20	S100 SAME (execut\$3 run\$4)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 15:45

S10 2	10739	(wafer) near (number)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2007/04/05 16:10
\$10 3	1793335	semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 16:10
S10 4	18820	wafer near position	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 16:10
S10 5	396	S102 SAME S104	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 16:10
S10 6	57	S105 SAME S103	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/05 16:10
S10 7	26	("4853844" "4866769" "4964074" "4967346" "4970640" "4974191" "5113518" "5121486" "5144551" "5163145" "5214652" "5287531" "5408611" "5426767" "5459854" "5640536" "5640537").PN. OR ("5794066").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/04/05 16:36
S10 8	6	("5671435" "5732207" "5774544" "5790663" "5794066").PN. OR ("6065113").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/04/05 16:38
S10 9	19	("4779188" "4866769" "4930065" "4967345" "4970640" "5113518" "5121486" "5144551" "5163145" "5408611" "5499342").PN. OR ("5671435").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/04/05 16:46